



CRYSTAL OSCILLATOR LOW-JITTER SAW OSCILLATOR

XG-1000CA/CB

- Output frequency range : 50 MHz to 170 MHz
- Supply voltage : 1.8 V / 2.5 V / 3.3 V
- Frequency tolerance : $\pm 50 \times 10^{-6}$, $\pm 100 \times 10^{-6}$
- Output : CMOS
- Function : Output enable (OE)
- Package size : CA: 7.0×5.0×1.2 mm
CB: 5.0×3.2×1.1 mm

- Very low jitter and low phase noise by SAW unit.



Product Number (please contact us)

XG-1000CA: Q3851CA00xxxx00

XG-1000CB: Q3851CB00xxxx00



Actual size

XG-1000CA



XG-1000CB



Specifications (characteristics)

Item	Symbol	Specifications			Conditions / Remarks
		E	D	C	
Output frequency range *1	fo	50.000 MHz to 170.000 MHz			Standard frequency
		75.000 MHz, 98.304 MHz, 100.000 MHz, 106.250 MHz, 125.000 MHz, 150.000 MHz			
Supply voltage	Vcc	1.8 V ± 0.1 V	2.5 V ± 0.125 V	3.3 V ± 0.3 V	
Storage temperature	T_stg	-40 °C to +100 °C			Store as bare product.
Operating temperature	T_use	-10 °C to +70 °C			
Frequency tolerance *2	f_tol	B: $\pm 50 \times 10^{-6}$ C: $\pm 100 \times 10^{-6}$			
Current consumption	Icc	20 mA Max.	25 mA Max.	35 mA Max.	OE=Vcc, No load condition
Disable current	I_dis	15 mA Max.	20 mA Max.	30 mA Max.	OE=GND
Symmetry	SYM	40 % to 60 %	45 % to 55 %		fo \leq 125 MHz fo $>$ 125 MHz
		40 % to 60 %			
Output voltage	V _{OH} V _{OL}	Vcc-0.35 V Min 0.35 V Max.			E: I _{OH} = -6 mA / C, D: I _{OH} = -8 mA E: I _{OL} = 6 mA / C, D: I _{OL} = 8 mA
Output load condition (CMOS)	L_CMOS	15 pF Max.			
Input voltage	V _{IH} V _{IL}	70 % Vcc Min. 30 % Vcc Max.			OE terminal
Rise time / Fall time	t _r / t _f	2 ns Max.			Between 20% Vcc and 80% Vcc level, L_CMOS \leq Max
Start-up time	t_str	10 ms Max.			Time at minimum supply voltage to be 0 s
Jitter *3	t _{RMS} t _{p-p}	3 ps Typ. 25 ps Typ.			σ (RMS of total distribution) Peak to Peak
Frequency aging	f_aging	$\pm 5 \times 10^{-6}$ / year Max.			+25 °C, First year, Vcc=1.8 V, 2.5 V, 3.3 V

*1 Please contact us for inquiries regarding non-standard frequencies.

*2 This includes initial frequency tolerance, temperature variation, supply voltage variation and load variation.

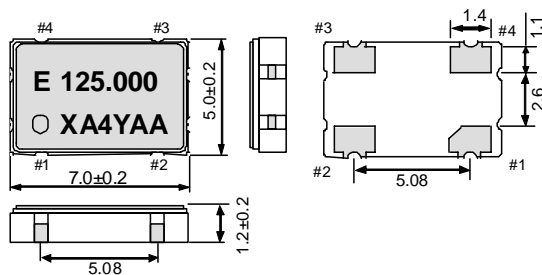
*3 Based on DTS-2075 Digital timing system made from WAVECREST with jitter analysis software VISI6.

Operating voltage		E: 1.8V	D: 2.5V	C: 3.3V
Frequency tolerance and operating temperature	B: $\pm 50 \times 10^{-6}$, (-10°C to +70°C) C: $\pm 100 \times 10^{-6}$, (-10°C to +70°C)	EB EC	DB DC	CB CC

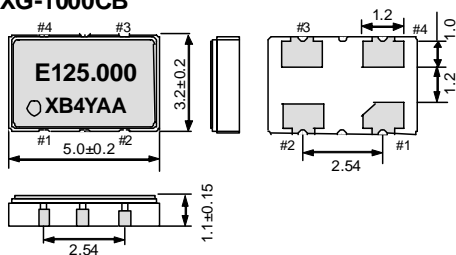
External dimensions

(Unit:mm)

● XG-1000CA



● XG-1000CB



Pin map

Pin	Connection
1	OE
2	GND
3	OUT
4	Vcc

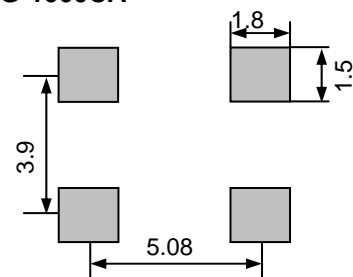
OE pin = HIGH : Specified frequency output.
 OE pin = LOW : Output is high impedance

#2 is connected to the cover

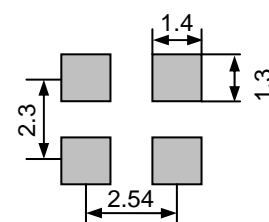
Footprint (Recommended)

(Unit:mm)

● XG-1000CA



● XG-1000CB



To maintain stable operation, provide a 0.01 μ F to 0.1 μ F by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

“QMEMS” EPSON TOYOCOM

In order to meet customer needs in a rapidly advancing digital, broadband and ubiquitous society, we are committed to offering products that are one step ahead of the market and a rank above the rest in quality. To achieve our goals, we follow a “3D (three device) strategy” designed to drive both horizontal and vertical growth. We will to grow our three device categories of “Timing Devices”, “Sensing Devices” and “Optical Devices”, and expand vertical growth through a combination of products from these categories.

A Quartz MEMS is any high added value quartz device that exploits the characteristics of quartz crystal material but that is produced using MEMS (micro-electro-mechanical system) processing technology.

Market needs are advancing faster than previously imagined toward smaller, more stable crystal products, but we will stay ahead of the curve by rolling out products that exceed market speed and quality requirements. We want to further accelerate the 3D strategy by QMEMS.

Quartz devices have become crucial in the network environment where products are increasingly intended for broadband, ubiquitous applications

and where various types of terminals can transfer information almost immediately via LAN and WAN on a global scale. Epson Toyocom Corporation addresses every single aspect within a network environment. The new corporation offers “Digital Convergence” solutions to problems arising with products for consumer use, such as, core network systems and automotive systems.



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PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Epson Toyocom, all environmental initiatives operate under the Plan-Do-Check-Action(PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.




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In order provide high quality and reliable products and services than meet customer needs,

Epson Toyocom made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired ISO/TS 16949 certification that is requested strongly by major automotive manufacturers as standard.

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► Explanation of the mark that are using it for the catalog

	► Pb free.
	► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
	► The products have been designed for high reliability applications such as Automotive.

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